Letter of Invitation

Dear Yanbin Zou

Affiliation: Shantou University, China

On behalf of the organizing committee of the 22nd IEEE Statistical Signal Processing Workshop (SSP), we are pleased to inform you that your below paper(s) have been accepted for presentation at the upcoming workshop to be held in Hanoi, Vietnam on July 2-5, 2023.

Paper ID: 1570894332
Title: Improved Weighted Least Squares Algorithm for Hybrid AOA and TDOA Localization
Authors: Yanbin Zou, Jingna Fan, Liehu Wu and Huaping Liu

The acceptance of your paper is made with the understanding that the camera-ready paper will be submitted by 15 May 2023 and at least one author must register and attend the workshop to present the paper(s). This letter serves as a formal invitation to you to come to Hanoi, Vietnam during July 2-5, 2023, to present the above paper(s) at the workshop.

The IEEE SSP workshop is one of the foremost international conferences on statistical signal processing and its applications. The 22nd edition of SSP will be held from 2-5 July 2023 in Hanoi. The program will feature six world-class plenary speakers for emerging topics, as well as regular and special sessions covering the latest research and innovation in the field. More information is available on the workshop website.

We look forward to welcoming you at SSP 2023 in Hanoi.

Yours truly,

**On behalf of the organizing committee,
Prof. Karim Abed-Meraim
General Co-Chair, SSP 2023**